

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Jung-Chih TSAO</td> <td>05/25/2012</td> </tr> <tr> <td>Yu-Sheng WANG</td> <td>05/25/2012</td> </tr> <tr> <td>Kei-Wei CHEN</td> <td>05/25/2012</td> </tr> <tr> <td>Ying-Lang WANG</td> <td>05/25/2012</td> </tr> </tbody> </table>		Name	Execution Date	Jung-Chih TSAO	05/25/2012	Yu-Sheng WANG	05/25/2012	Kei-Wei CHEN	05/25/2012	Ying-Lang WANG	05/25/2012
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PROPERTY NUMBERS Total: 1											
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CORRESPONDENCE DATA											
<p>Fax Number: (770)951-0933</p> <p>Phone: 770-933-9500</p> <p>Email: dan.mcclure@tkhr.com</p> <p><i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i></p> <p>Correspondent Name: THOMAS, KAYDEN, HORSTEMEYER & RISLEY, LL</p> <p>Address Line 1: 400 INTERSTATE NORTH PARKWAY SE</p> <p>Address Line 2: SUITE 1500</p> <p>Address Line 4: ATLANTA, GEORGIA 30339</p>											
ATTORNEY DOCKET NUMBER:	252011-4291										
NAME OF SUBMITTER:	Daniel R. McClure										
<p>Total Attachments: 2</p> <p>source=01636120#page1.tif</p> <p>source=01636120#page2.tif</p>											

OP \$40.00 13488958

ASSIGNMENT

WHEREAS, Jung-Chih TSAO, Yu-Sheng WANG, Kei-Wei CHEN and Ying-Lang WANG hereafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: SEMICONDUCTOR DEVICE
Filed: _____ Serial No. _____
Executed on: May 25, 2012

WHEREAS, Taiwan Semiconductor Manufacturing Co., Ltd. of No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park, Hsin-Chu, Taiwan 300-77, R.O.C. hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Jung-chih Tsao

Jung-Chih TSAO

05/25/2012

Date:

Yu-Sheng Wang

Yu-Sheng WANG

05/25/2012

Date:

Kai-Wei Chen

Kai-Wei CHEN

05/25/2012

Date:

Ying-Lang Wang

Ying-Lang WANG

05/25/2012

Date:

TSMC2006-0595/0503-A32547CIPUS

PATENT

RECORDED: 06/05/2012

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